Unit: mm

TOSHIBA Field-Effect Transistor Silicon P-Channel MOS Type

# SSM6J207FE

### High-Speed Switching Applications

• 4 V drive

• Low ON-resistance:  $R_{on} = 491 \text{ m}\Omega \text{ (max) (@V_{GS} = -4 V)}$ 

 $R_{on} = 251 \text{ m}\Omega \text{ (max) } (@V_{GS} = -10 \text{ V})$ 

### Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit	
Drain-source voltage		$V_{DS}$	-30	V	
Gate-source voltage		V <sub>GSS</sub>	± 20	V	
Drain current	DC	I <sub>D</sub>	-1.4	Α	
	Pulse	I <sub>DP</sub>	-2.8		
Drain power dissipation		P <sub>D</sub> (Note 1)	500	mW	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature		T <sub>stg</sub>	-55 to 150	°C	

Note:

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on an FR4 board

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ t}, \text{ Cu Pad: } 645 \text{ mm}^2)$ 

# 1, 2, 5, 6 : Drain 3 : Gate 4 : Source ES6 JEDEC JEITA 1.6±0.05 1.2±0.0

2-2N1A

Weight: 3 mg (typ.)

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### **Electrical Characteristics (Ta = 25°C)**

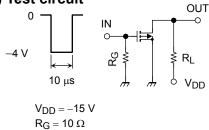
Characte	eristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain–source breakdown voltage		V (BR) DSS	$I_D = -1 \text{ mA}, V_{GS} = 0$	-30	_	_	V
		V (BR) DSX	$I_D = -1 \text{ mA}, V_{GS} = +20 \text{ V}$	-15	_	_	
Drain cutoff current		I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = 0$	_	_	-1	μА
Gate leakage curre	nt	I <sub>GSS</sub>	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$	_	_	±1	μА
Gate threshold volta	age	V <sub>th</sub>	$V_{DS} = -5 \text{ V}, I_D = -1 \text{ mA}$	-1.2	_	-2.6	V
Forward transfer ad	Imittance	Y <sub>fs</sub>	$V_{DS} = -5 \text{ V}, I_D = -0.65 \text{ A}$ (Note 2)	0.8	1.5	_	S
Drain-source ON-resistance		R <sub>DS</sub> (ON)	$I_D = -0.65 \text{ A}, V_{GS} = -10 \text{ V}$ (Note 2)	_	191	251	mΩ
			$I_D = -0.4 \text{ A}, V_{GS} = -4 \text{ V}$ (Note 2)	_	371	491	
Input capacitance		C <sub>iss</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	137	_	pF
Output capacitance		Coss	$V_{DS} = -15 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	39	_	pF
Reverse transfer ca	pacitance	C <sub>rss</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	20	_	pF
Switching time	Turn-on time	t <sub>on</sub>	$V_{DD} = -15 \text{ V}, I_D = -0.65 \text{ A},$ $V_{GS} = 0 \text{ to } -4 \text{ V}, R_G = 10 \Omega$	_	15	_	ns
	Turn-off time	t <sub>off</sub>		_	14	_	
Drain-source forward voltage		V <sub>DSF</sub>	$I_D = 1.4 \text{ A}, V_{GS} = 0 \text{ V}$ (Note 2)	_	0.85	1.2	V

Note 2: Pulse test

Start of commercial production 2005-12

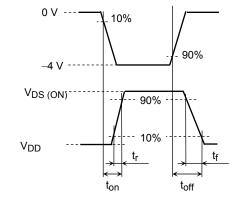
# **Switching Time Test Circuit**

(a) Test circuit



(b) V<sub>IN</sub>

(c) Vout



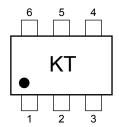
Duty ≤ 1%

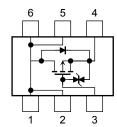
 $V_{IN}\text{: }t_{r}\text{, }t_{f}<5\text{ ns}$ Common Source

 $Ta = 25^{\circ}C$ 

# Marking

# **Equivalent Circuit (top view)**





# **Notice on Usage**

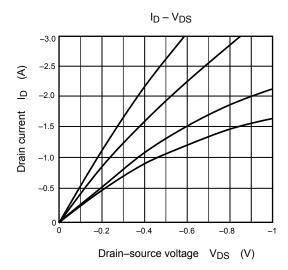
Vth can be expressed as the voltage between gate and source when the low operating current value is ID = -1 mA for this product. For normal switching operation, VGS (on) requires a higher voltage than Vth and VGS (off) requires a lower voltage than V<sub>th</sub>.

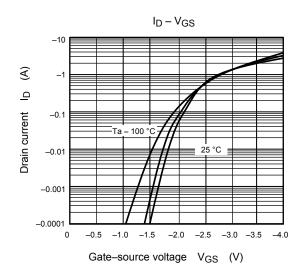
(The relationship can be established as follows: V<sub>GS (off)</sub> < V<sub>th</sub> < V<sub>GS (on).</sub>)

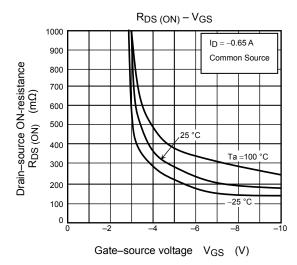
Take this into consideration when using the device.

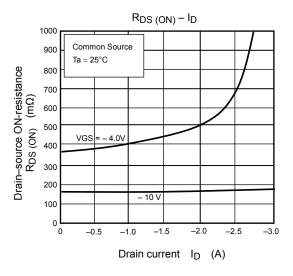
### **Handling Precaution**

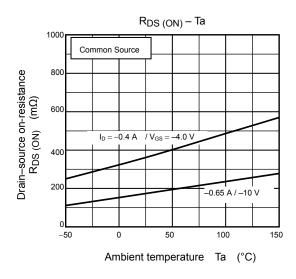
When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

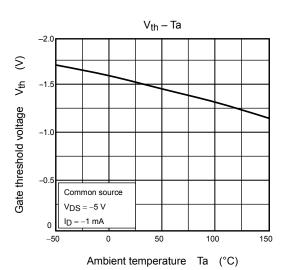


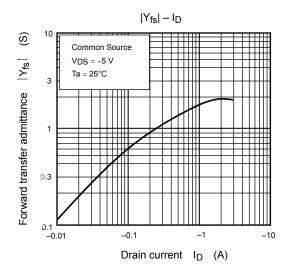


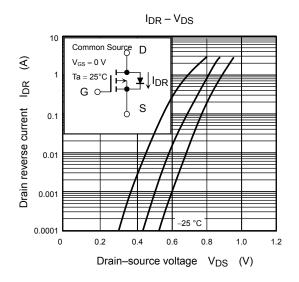


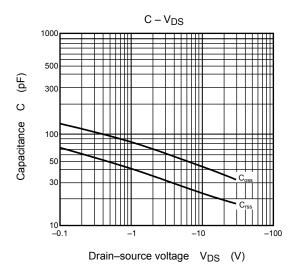


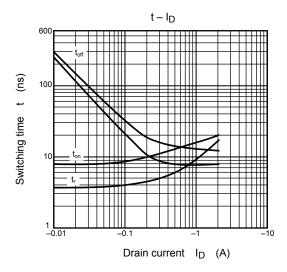


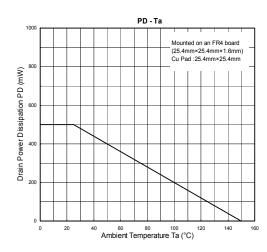












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